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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

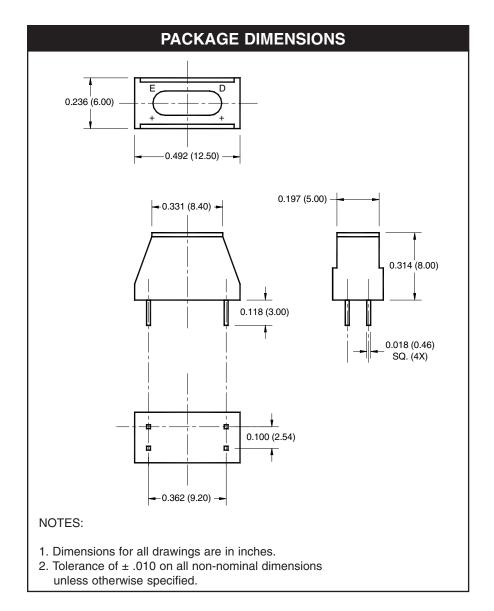
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

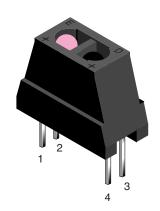


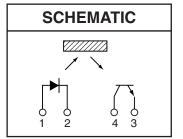




QRE00034







DESCRIPTION

The QRE00034 reflective object sensor consists of an infrared emitting diode and an NPN phototransistor mounted side by side on a converging optical axis in a black housing. The phototransistor responds to radiation from the emitting diode only when a reflective object passes in its field of view.

FEATURES

- Phototransistor output
- No contact surface sensing
- · Daylight filter on the sensor
- Emitter $\lambda = 940 \text{ nm}$



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Parameter	Symbol	Rating	Units	
Operating Temperature	T _{OPR}	-40 to +85	°C	
Storage Temperature	T _{STG}	-40 to +85	°C	
Soldering Temperature (Iron)(2,3,4)	T _{SOL-I}	240 for 5 sec	°C	
Soldering Temperature (Flow)(2,3)	T _{SOL-F}	260 for 10 sec	°C	
EMITTER		50	mA	
Continuous Forward Current	I _F	50		
Reverse Voltage	V _R	5	V	
Peak Forward Current	I _{FP}	1	Α	
Power Dissipation ⁽¹⁾	PD	100	mW	
SENSOR	V	30	V	
Collector-Emitter Voltage	V _{CEO}	30		
Power Dissipation ⁽¹⁾	P _D	100	mW	

ELECTRICAL / OPTICAL CHARACTERISTICS (T _A = 25°C)									
PARAMETER	TEST CONDITIONS	SYMBOL	MIN	TYP	MAX	UNITS			
EMITTER	I- 00 m A	VF	_	_	1.7	V			
Forward Voltage	IF = 20 mA								
Reverse Current	$V_R = 5 V$	I_{R}	_	_	100	μΑ			
Peak Emission Wavelength	$I_F = 20 \text{ mA}$	λ_{PE}	_	940	_	nm			
SENSOR			_	_	100	nA			
Dark Current	$V_{CE} = 10 \text{ V}, \text{ If } = 0 \text{ mA}$	lo							
Peak Sensitivity Wavelength	$V_{CE} = 5 V$	λ_{PS}	_	880	_	nm			
COUPLED	1 00 1 10 1 (0.7)		0.40	_	2.00	mA			
Collector Current	$I_F = 20 \text{ mA}, V_{CE} = 10 V^{(6,7)}$	Ic(on)	0.16						
Collector Emitter	I _F = 20 mA, I _C = 0.5 mA	VCE (SAT)	_	_	0.4	V			
Saturation Voltage									
Rise Time	V_{CE} = 5 V, R_{L} = 100 Ω	tr	_	10	_	μs			
Fall Time	$I_{C(ON)} = 5 \text{ mA}$	t _f	_	50	_	μs			

NOTES

- 1. Derate power dissipation linearly 1.33 mW/°C above 25°C.
- 2. RMA flux is recommended.
- 3. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 4. Soldering iron tip at 1/16" (1.6mm) from housing.
- 5. Pulse conditions: tp = 10 μ s; T = 1 ms.
- 6. Measured as an Eastman Kodak neutral white test card with 90% diffused reflectance as a reflecting surface.
- 7. 0.160" (4 mm) distance from sensor face to reflector surface.



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TYPICAL PERFORMANCE CURVES

Fig. 1 Normalized Collector Current vs. Distance (CON) - NORMALIZED COLLECTOR CURRENT 1.0 0.8 Sensing Object-90% reflective card d 0.6 0.4 alized to highest value 0.2 $T_A = 25^{\circ}C$ I_F = 20 mA V_{CE} = 5 V 0.0 2 3 6 8 9 10 d - DISTANCE (mm)

Fig. 3 Normalized Collector Current vs. Angle Deviation

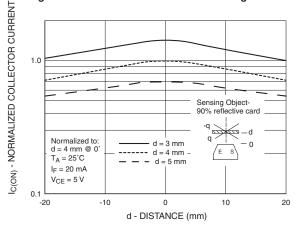


Fig. 5 Normalized Collector Current vs. Ambient Temperature

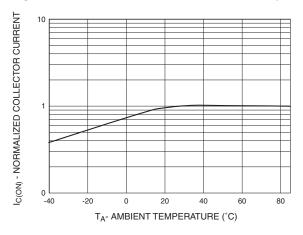


Fig. 2 Forward Current vs. Forward Voltage

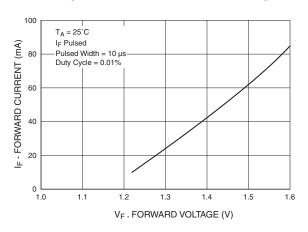


Fig. 4 Collector Current vs. Forward Current

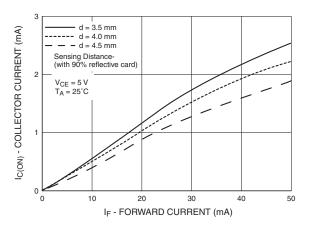
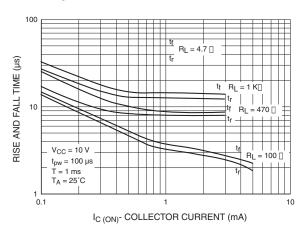


Fig. 6 Rise and Fall Time vs. Collector Current





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Fig. 7 Collector Current vs. Collector to Emitter Voltage

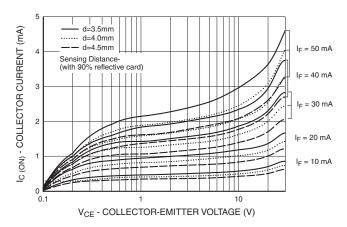


Fig. 8 Collector Emitter Dark Current vs. Forward Current

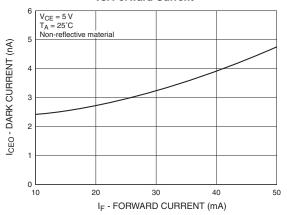


Fig. 9 Forward Voltage vs. Ambient Temperature

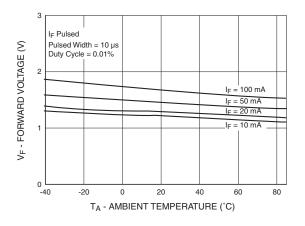


Fig. 10 Normalized Collector Current vs. Distance d₂

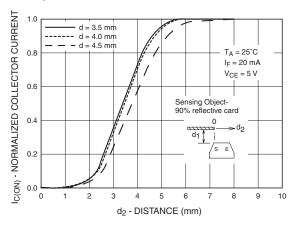


Fig. 11 Normalized Collector Current vs. Distance d₂

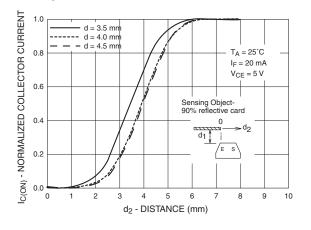
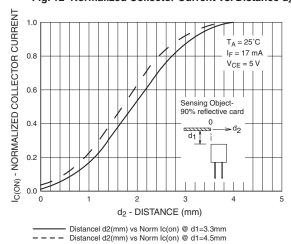
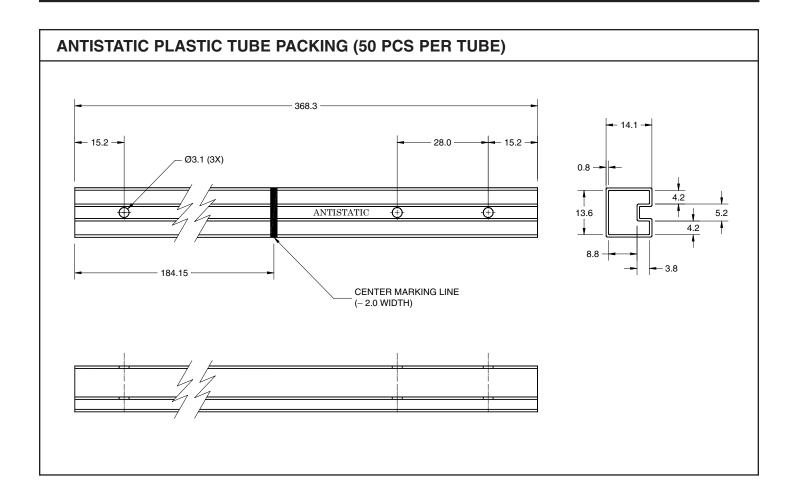


Fig. 12 Normalized Collector Current vs. Distance d₂





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NOTES

- 1. Dimensions: All dimensions are in mm.
- 2. Color: Clear (Transparent).
- 3. Antistatic resistivity level: 10⁵ 10¹² Ohm/sq.
- 4. Tolerance: ±0.25 inches, unless otherwise specified.



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